LNJ047X8ARA

Hight Bright Surface Mounting Chip LED

1005 Type

\blacksquare Absolute Maximum Ratings $\,T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	40	mW	
Forward current	I_{F}	10	mA	
Pulse forward current *	I_{FP}	40	mA	
Reverse voltage	V _R	5	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

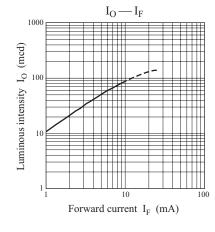
■ Lighting Color

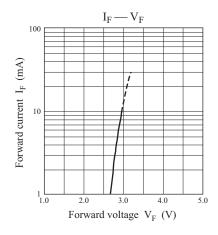
• White

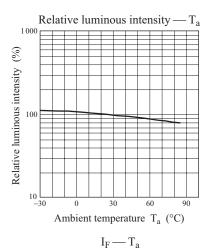
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

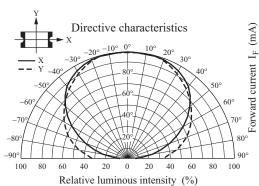
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 5 \text{ mA}$	20.0	50.0	111.0	mcd
Reverse current	I_R	$V_R = 5 V$			10	μΑ
Forward voltage	V _F	$I_F = 5 \text{ mA}$		2.90	3.20	V
Chromaticity coordinates –	X	$I_F = 5 \text{ mA}$	0.204	0.247	0.290	_
	у	$I_F = 5 \text{ mA}$	0.172	0.234	0.291	_

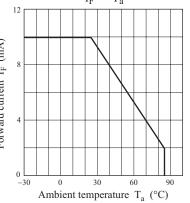
Note) *: Measurement tolerance: ±20%





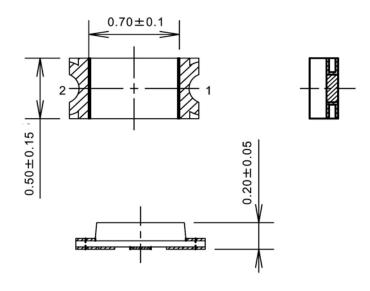


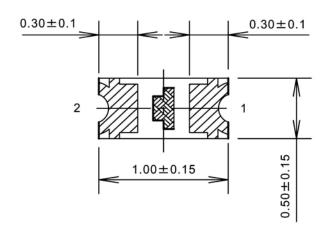




■ Package (Unit: mm)

KLTFTN2K4700





- Pin name
 - 1: Anode
 - 2: Cathode

2 Ver. AEK

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